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Part Number: [74300-0143](#)
Status: **Active**
Overview: [HDM® Backplane Connector System](#)
Description: HDM® Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, with Guide, 72 Circuits, Mounted Height 13.00mm, Pin Length 3.00mm, Lead-Free

Documents:
[3D Model](#) [Product Specification PS-73780-999 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

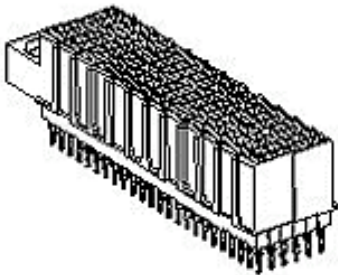
UL E29179

General

Product Family Backplane Connectors
Series [74300](#)
Application Daughtercard, Mezzanine
Component Type PCB Receptacle
Overview [HDM® Backplane Connector System](#)
Product Name HDM®
Style N/A
UPC 756054576328

Physical

Circuits (Loaded) 72
Circuits (maximum) 72
Color - Resin Black
Durability (mating cycles max) 250
First Mate / Last Break No
Flammability 94V-0
Guide to Mating Part Yes
Keying to Mating Part None
Material - Metal Copper-Nickel-Tin
Material - Plating Mating Gold
Material - Plating Termination Matte Tin
Material - Resin High Temperature Thermoplastic
Net Weight 7.825/g
Number of Columns 24
Number of Pairs Open Pin Field
Number of Rows 6
Orientation Vertical
PC Tail Length 3.00mm
PCB Locator No
PCB Retention None
PCB Thickness - Recommended 1.60mm
Packaging Type Tube
Pitch - Mating Interface 2.00mm
Pitch - Termination Interface 2.00mm
Plating min - Mating 0.762µm
Plating min - Termination 2.540µm
Polarized to PCB No
Stackable Yes
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -55°C to +105°C
Termination Interface: Style Through Hole - Compliant Pin



Series

image - Reference only

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Low-Halogen Status
Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[74300Series](#)

Mates With
HDM® Board-to-Board Backplane Header
[73642](#) , [73643](#) , [73644](#) , [74349](#) , [74428](#) ,
[73769](#) , [73781](#) , [73770](#) , [73782](#) , [73783](#) ,
[73771](#)

Electrical

Current - Maximum per Contact	1A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	76
Shielded	Yes
Voltage - Maximum	250V AC

Solder Process Data

Duration at Max. Process Temperature (seconds)	40
Lead-free Process Capability	SMC & Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	3
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Product Specification	PS-73780-999
Sales Drawing	SD-74300-004

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